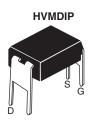


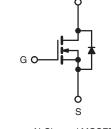
Vishay Siliconix



Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	200				
R _{DS(on)} (Ω)	V _{GS} = 10 V 1.5				
Q _g (Max.) (nC)	8.2				
Q _{gs} (nC)	1.8				
Q _{gd} (nC)	4.5				
Configuration	Sing	le			





N-Channel MOSFET

D

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- For Automatic Insertion
- End Stackable
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION		
Package	HVMDIP	
Lead (Pb)-free	IRFD210PbF	
	SiHFD210-E3	
SnPb	IRFD210	
	SiHFD210	

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	200	v	
Gate-Source Voltage			V _{GS}	± 20	v	
Continuous Drain Current	V _{GS} at 10 V	T _A = 25 °C		0.60	А	
Continuous Drain Current		T _A = 100 °C	l _D	0.38		
Pulsed Drain Current ^a			I _{DM}	4.8		
Linear Derating Factor				0.0083	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	79	mJ	
Repetitive Avalanche Current ^a			I _{AR}	0.60	А	
Repetitive Avalanche Energy ^a			E _{AR}	0.10	mJ	
Maximum Power Dissipation $T_A = 25 \text{ °C}$			PD	1.0	W	
Peak Diode Recovery dV/dt ^c			dV/dt	5.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150		
Soldering Recommendations (Peak Temperature)	Recommendations (Peak Temperature) for 10 s			300 ^d		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 82 mH, R_g = 25 Ω , I_{AS} = 1.2 A (see fig. 12).

c. $I_{SD} \leq 3.3$ A, dl/dt ≤ 70 A/µs, $V_{DD} \leq V_{DS}$, $T_J \leq 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	120	°C/W

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		- -					
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	200	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Referen	ce to 25 °C, I _D = 1 mA	-	0.30	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS}	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
Zere Oete Meltere Dreie Orment		V _{DS} :	$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}$		-	25	μA
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 160 V	V_{DS} = 160 V, V_{GS} = 0 V, T_{J} = 125 °C		-	250	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}$	I _D = 0.36 A ^b	-	-	1.5	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	= 50 V, I _D = 0.36 A ^b	0.10	-	-	S
Dynamic							
Input Capacitance	C _{iss}		V _{GS} = 0 V V _{DS} = 25 V		140	-	pF
Output Capacitance	Coss				53	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.	.0 MHz, see fig. 5	-	15	-	
Total Gate Charge	Qg			-	-	8.2	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 3.3 \text{ A}, V_{DS} = 160 \text{ V}$ see fig. 6 and 13 ^b	-	-	1.8	nC
Gate-Drain Charge	Q_gd		j ta t	-	-	4.5	nC
Turn-On Delay Time	t _{d(on)}			-	8.2	-	
Rise Time	t _r	Vpp -	= 100 V, I _D = 3.3 A	-	17	-	
Turn-Off Delay Time	t _{d(off)}		$R_D = 30 \Omega$, see fig. 10^{b}	-	14	-	ns
Fall Time	t _f			-	8.9	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from - 4.0 -		-			
Internal Source Inductance	Ls	die contact		-	6.0	-	- nH
Drain-Source Body Diode Characteristic	s	-					
Continuous Source-Drain Diode Current	۱ _S	showing the	MOSFET symbol showing the		-	0.60	^
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction		-	-	4.8	A
Body Diode Voltage	V _{SD}	T _J = 25 °C,	$I_{\rm S} = 0.60$ A, $V_{\rm GS} = 0$ V ^b	-	-	2.0	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 00 1		-	150	310	ns
Body Diode Reverse Recovery Charge	Q _{rr}			1.4	μC		
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	y L _S and	L _D)

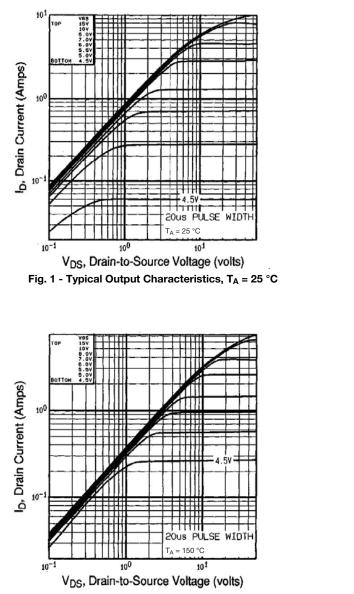
Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %



Vishay Siliconix



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 2 - Typical Output Characteristics, $T_A = 150$ °C

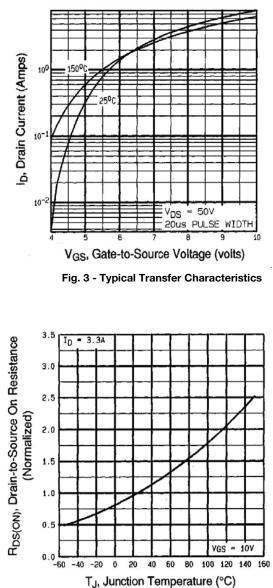


Fig. 4 - Normalized On-Resistance vs. Temperature

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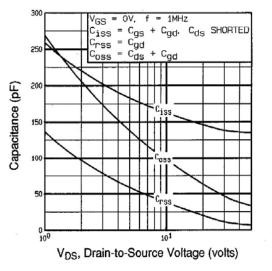
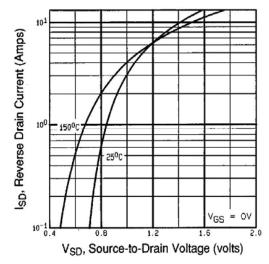


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





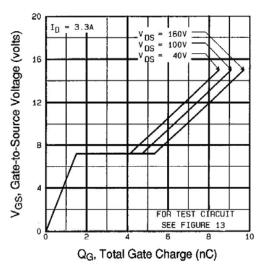
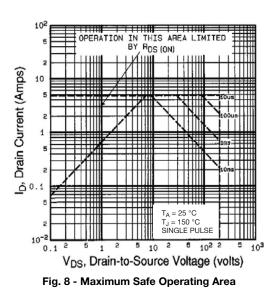


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage





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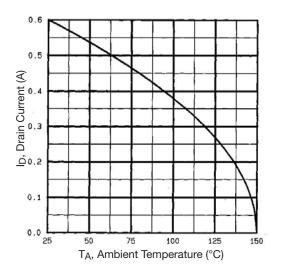


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

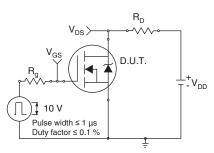


Fig. 10a - Switching Time Test Circuit

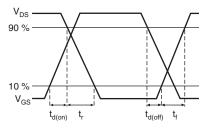


Fig. 10b - Switching Time Waveforms

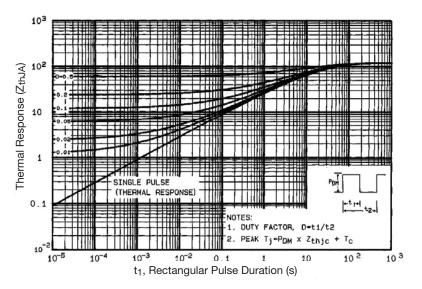


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

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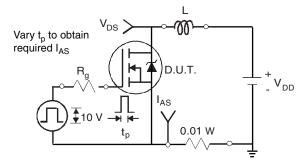


Fig. 12a - Unclamped Inductive Test Circuit

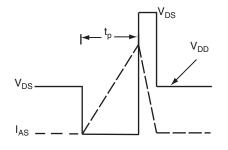


Fig. 12b - Unclamped Inductive Waveforms

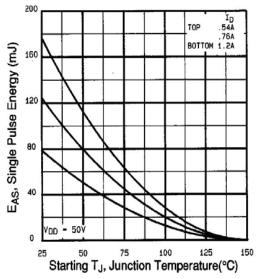


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

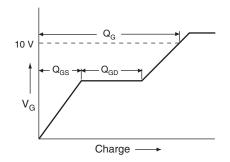
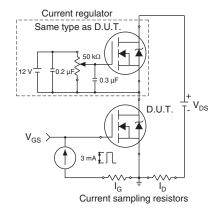


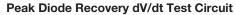
Fig. 13a - Basic Gate Charge Waveform

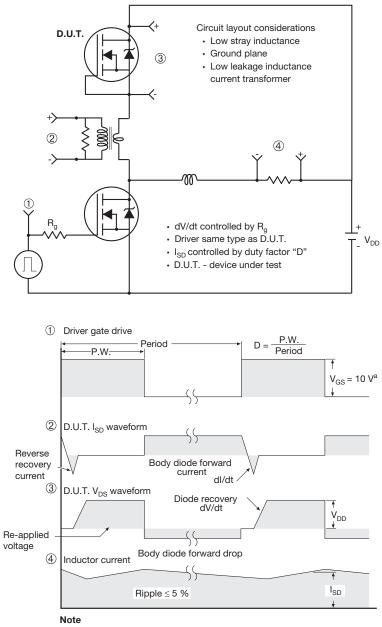






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a. $V_{GS} = 5$ V for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg291129.



Vishay Siliconix

HVM DIP (High voltage)





	INC	HES	MILLIN	IETERS
DIM.	MIN.	MAX.	MIN.	MAX.
А	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36
ECN: X10-0386-Rev. B, 0 DWG: 5974	06-Sep-10			

Note

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.



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